

Description

The ZXMP3F30FHTA uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = -30V, I_D = -4.1A$ $R_{DS(ON)} < 56m\Omega @ V_{GS} = 10V$

Application

High power and current handing capability Lead free product is acquired Surface mount package PWM applications Load switch Power management







P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
ZXMP3F30FHTA	SOT-23	3407 XXXX	3000PCS

Absolute Maximum Ratings (T_A=25[°]C unless otherwise noted)

Symbol	Parameter	Limit	Unit
VDS	Drain-Source Voltage	-30	V
Vgs	Gate-Source Voltage	±20	V
ID	Drain Current-Continuous	-4.1	А
Ідм	Drain Current-Pulsed (Note 1)	-13	А
PD	Maximum Power Dissipation	1.32	W
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	125	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V	
$\triangle BV_{\text{DSS}} / \triangle T_{\text{J}}$	BVDSS Temperature Coefficient	Reference to 25°C , I⊳=-1mA		-0.02		V/°C	
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-3A		48	56	mΩ	
	Static Drain-Source On-Resistance-	V _{GS} =-4.5V , I _D =-1.5A		78	90		
$V_{GS(th)}$	Gate Threshold Voltage		-1.2	-1.5	-2.5	V	
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	──V _{GS} =V _{DS} , I _D =-250uA		4.32		mV/°C	
IDSS	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =25°C			-1	uA	
		V _{DS} =-24V , V _{GS} =0V , T _J =55°C			-5		
lgss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-3A		4.8		S	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		24	48	Ω	
Qg	Total Gate Charge (-4.5V)			5.22	7.3	nC	
Q _{gs}	Gate-Source Charge	V_{DS} =-20V , V_{GS} =-4.5V , I_{D} =-3A		1.25	1.8		
\mathbf{Q}_{gd}	Gate-Drain Charge			2.3	3.2		
T _{d(on)}	Turn-On Delay Time			18.4	37		
Tr	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_G =3.3 Ω		11.4	21	- ns	
T _{d(off)}	Turn-Off Delay Time	I _D =-1A		39.4	79		
T _f	Fall Time			5.2	10.4		
Ciss	Input Capacitance			463	650		
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		82	115	pF	
Crss	Reverse Transfer Capacitance			68	95		
Is	Continuous Source Current ^{1,4}				-3.2	А	
I _{SM}	Pulsed Source Current ^{2,4}	$V_{G}=V_{D}=0V$, Force Current			-13	А	
Vsd	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C			-1	V	

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width ≤ 300 us , duty cycle $\leq 2\%$ 3.The power dissipation is limited by 150°C junction temperature

4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics



Fig.5 Normalized V_{GS(th)} vs. T_J



Fig.2 On-Resistance vs. G-S Voltage



Fig.4 Gate-Charge Characteristics



Fig.6 Normalized RDSON vs. TJ





Fig.9 Normalized Maximum Transient Thermal Impedance



Fig.10 Switching Time Waveform

Fig.11 Gate Charge Waveform



SOT-23 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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